LN29RPX

Round Type

φ4.0 mm

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	70	mW	
Forward current	I _F	25	mA	
Pulse forward current *	I _{FP}	150	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

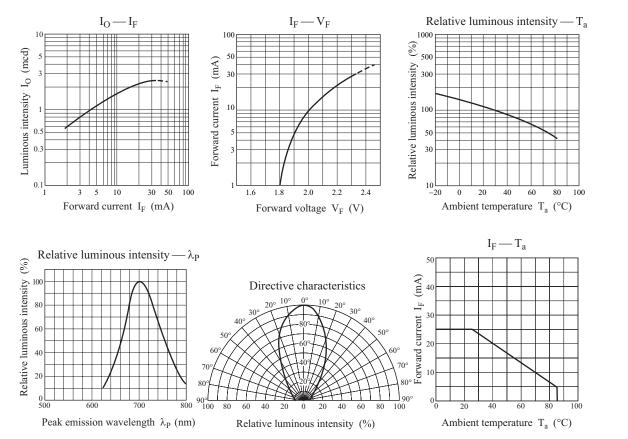
Lighting Color

• Red

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

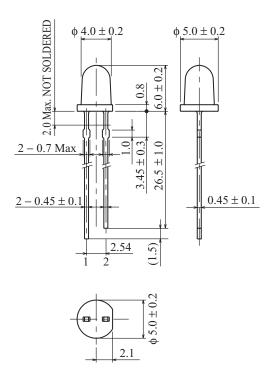
Electro-Optical Characteristics $T_a = 25^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O		0.8	2.0		mcd
Reverse current	I _R	$V_R = 4 V$			5	μΑ
Forward voltage	V _F	$I_{\rm F} = 20 {\rm mA}$		2.2	2.8	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_{\rm F} = 20 {\rm mA}$		700		nm
Spectral half band width	Δλ	$I_{\rm F} = 20 {\rm mA}$		100		nm



Package (Unit: mm)

LLXLTN2SK090



• Pin name

1: Anode

2: Cathode

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